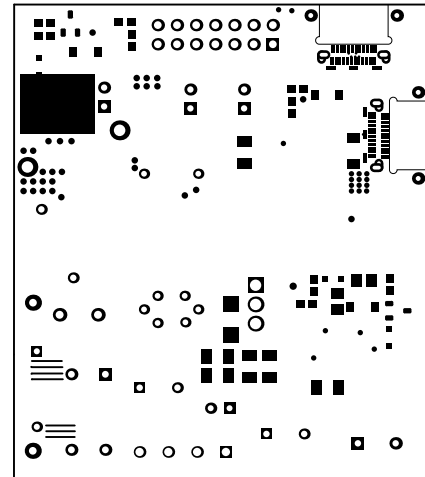
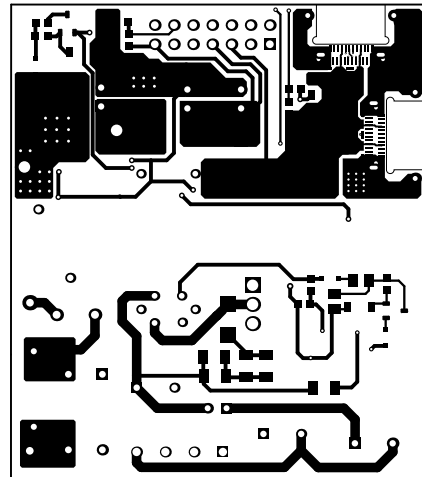


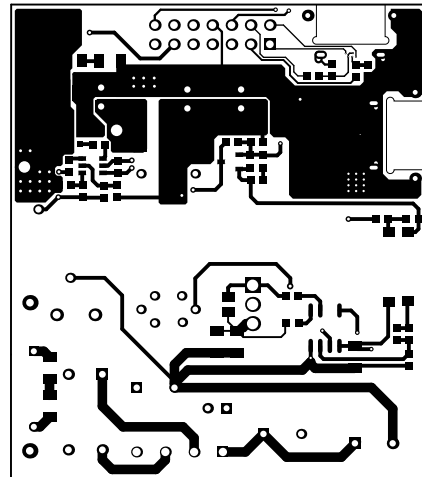
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40060	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: N/A		
PLOT NAME = Top Overlay	GENERATED : 11/28/2016 11:20:39 AM	TEXAS INSTRUMENTS	



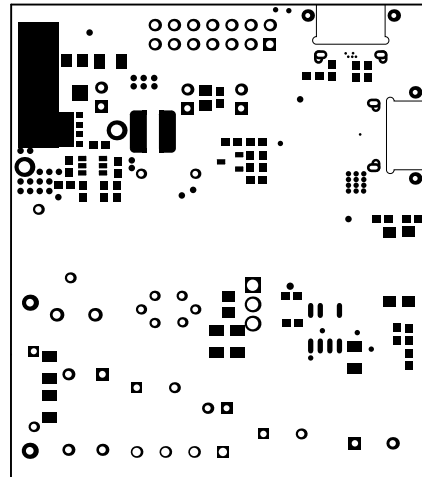
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40060	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: N/A		
PLOT NAME = Top Solder Mask	GENERATED : 11/28/2016 11:20:41 AM	TEXAS INSTRUMENTS	



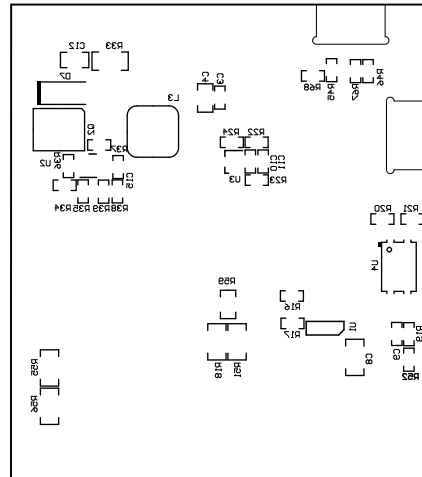
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40060	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: N/A		
PLOT NAME = Top Layer	GENERATED : 11/28/2016 11:20:42 AM	TEXAS INSTRUMENTS	



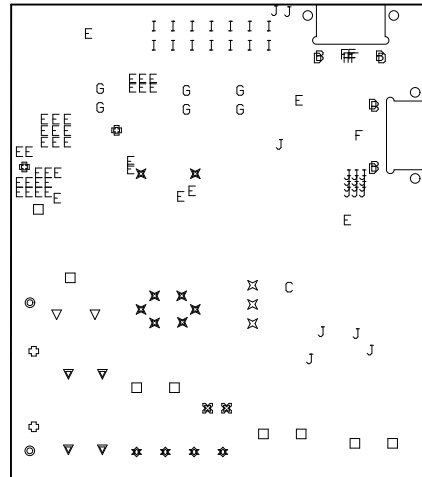
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40060	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: N/A		
PLOT NAME = Bottom Layer	GENERATED : 11/28/2016 11:20:43 AM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40060	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: N/A		
PLOT NAME = Bottom Solder Mask	GENERATED : 11/28/2016 11:20:44 AM	TEXAS INSTRUMENTS	



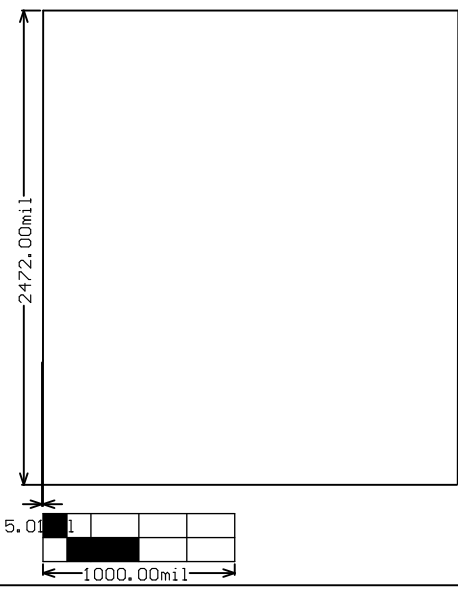
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40060	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: N/A		
PLOT NAME = Bottom Overlay	GENERATED : 11/28/2016 11:20:46 AM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
F	6	5.00mil (0.127mm)	PTH	Round	Top Layer - Bottom Layer	
J	19	12.00mil (0.305mm)	PTH	Round	Top Layer - Bottom Layer	
E	36	15.00mil (0.381mm)	PTH	Round	Top Layer - Bottom Layer	
C	1	16.00mil (0.406mm)	PTH	Round	Top Layer - Bottom Layer	
O	4	25.59mil (0.650mm)	PTH	Round	Top Layer - Bottom Layer	
X	8	30.00mil (0.762mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	2	31.00mil (0.787mm)	PTH	Round	Top Layer - Bottom Layer	
⊕	2	31.50mil (0.800mm)	PTH	Round	Top Layer - Bottom Layer	
G	6	33.00mil (0.838mm)	PTH	Round	Top Layer - Bottom Layer	
□	8	33.46mil (0.850mm)	PTH	Round	Top Layer - Bottom Layer	
▽	4	35.43mil (0.900mm)	PTH	Round	Top Layer - Bottom Layer	
⊙	2	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	
I	14	40.16mil (1.020mm)	PTH	Round	Top Layer - Bottom Layer	
∇	2	41.34mil (1.050mm)	PTH	Round	Top Layer - Bottom Layer	
*	4	43.31mil (1.100mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	3	59.06mil (1.500mm)	PTH	Round	Top Layer - Bottom Layer	
⊕	2	60.00mil (1.524mm)	PTH	Round	Top Layer - Bottom Layer	
B	4	19.69mil (0.500mm)	PTH	Slot	Top Layer - Bottom Layer	
D	4	19.69mil (0.500mm)	PTH	Slot	Top Layer - Bottom Layer	
	131 Total					

Slot definitions : Routed Path Length = Calculated from tool start centre position to tool end centre position.
Hole Length = Routed Path Length + Tool Size = Slot length as defined in the PCB layout

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40060	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: N/A		
PLOT NAME = Drill Drawing	GENERATED : 11/28/2016 11:20:47 AM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40060	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: N/A		
PLOT NAME = Board Dimensions	GENERATED : 11/28/2016 11:20:49 AM	TEXAS INSTRUMENTS	

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